

# Agilent 87406B Coaxial Matrix Switch dc to 20 GHz

Product Overview



Modern automated test systems demand higher accuracy and performance than ever before. The Agilent Technologies 87406B matrix switch offers improvements in insertion loss repeatability and isolation necessary to achieve higher test system performance. Long life, excellent repeatability, and high reliability lowers the cost of ownership by reducing calibration cycles and increasing test system uptime that are vital to ATS measurement system integrity.

# Description

The 87406B matrix switch provides the life and reliability required for automated test and measurement, signal monitoring, and routing applications. Innovative design and careful process control creates a switch that meets the requirements for highly repeatable switching elements in test instruments and switching interfaces. The switch is designed to operate for more than 10 million cycles and will meet all electrical specifications for at least 5 million cycles.

# High performance matrix switch for RF and microwave test systems

- 3 x 3, 2 x 4, and 1 x 5 blocking matrix configurations
- Magnetic latching
- Make-before-break or break-before-make operation
- Exceptional repeatability for more than 5 million cycles
- Excellent isolation, typically >100 dB at 20 GHz
- Opto-electronic indicators and interrupts
- Terminated ports
- TTL/5V CMOS compatible (optional)

The switch exhibits exceptional insertion loss repeatability. This reduces sources of random errors in the measurement path and improves measurement uncertainty. Switch life is a critical consideration in production test systems, satellite and antenna monitoring systems, and test instrumentation. The longevity of the switch increases system uptime, and lowers the cost of ownership by reducing calibration cycles and switch maintenance.





Figure 1. Agilent 87406B connection diagram and simplified schematic (RF path 4 to 1 shown)

Operating to 20 GHz, this switch exhibits the exceptional isolation performance required to maintain measurement integrity. Isolation between ports is typically >100 dB to 20 GHz. This reduces the influence of signals from other channels, sustains the integrity of the measured signal, and reduces system measurement uncertainties. This switch also minimizes measurement uncertainty with low insertion loss and reflection, which makes it an ideal element in large, multi-tiered switching systems. The 87406B is designed to fall within most popular industry footprints. The  $2^{1/4}$  inch square flange provides mounting holes, while the rest of the  $2^{1/2}$  inch long by  $2^{1/4}$  inch diameter body will easily fit into most systems. Ribbon cable or optional solder terminal connections accommodate the need for secure and efficient control cable attachment. Option 100 provides solder terminal connections in place of the 16-pin ribbon drive cable. Option 100 does not incorporate the "open all paths" feature. Opto-electronic interrupts and indicators improve reliability and extend the life of the switch by eliminating DC circuit contact failures characteristic of conventional electromechanical switches. This switch has an interrupt circuit that provides logic to open all but the selected ports, then closes the selected ports and the current to all the solenoids is then cut off. This switch also offers independent indicators that are controlled by optical interrupts in the switch. The indicators provide a connection between the indicator common pin and the corresponding sense pin of the selected port.

All unselected RF ports are terminated with 50 ohm loads.

## Applications Matrix signal routing

Figures 2 and 3 show the 87406B configured for blocking 2 x 4 and 3 x 3 applications. With outstanding repeatability and life greater than 5 million cycles, these switches enhance measurement confidence and reduce cost of ownership. In addition, the matrix switch has the versatility to provide single pole multiple throw signal routing up to 1 x 5 (SP5T). For applications requiring only single pole multiple throw signal routing, the 87104 and 87106 series high performance switches are recommended.





Information on switch drivers can be found on page 9 of this document. For additional information, request publication number 5963-2038E, *Agilent 70611A, 87130A, and 11713A Switch and Attenuator Driver Configuration Guide.* 

## **General operation**

The 87406B matrix switch consists of 6 ports which can be individually connected via internal microwave switches to form an RF path (see Figure 4). When control inputs are sent to the switch, the internal diode logic and position sensing circuitry routes current to the appropriate solenoids to close or open the microwave switches based on the input state. The position sensing circuitry utilizes opto-electronic components to determine the position of the individual internal microwave switches. Each internal microwave switch has two solenoids: one to select or close the RF port, and one to unselect or open the RF port.

Each solenoid requires 200 mA @ 24 VDC nominal. The position sensing circuits serve three purposes: to enable solenoids that need to be switched, to interrupt the solenoid current once the individual internal microwave switch is closed or opened, and to power the position indicator circuits. The solenoid current is interrupted once the switching solenoids are magnetically latched. The drive current then returns to the standby level that is required by the opto-electronic components. When a control input is applied, all RF ports that have no enabling control input are automatically opened by the internal logic circuitry.

To configure a desired RF path, two ports must be engaged which requires a control input for each port to be maintained. If the input is removed from either port, that port will be automatically opened by the internal logic circuitry. All of the "open" solenoids are internally connected to pin 16 via diode logic circuitry (Option 161 and T24 only). If no input is present at any of the port select pins (3, 5, 7, 9, 11, 13), all of the RF ports will be opened if pin 16 is selected.



Figure 3. Matrix switch configured for a 3 x 3 blocking application (RF Path 5 to 1 shown)



Figure 4. Agilent 87406B block diagram

#### General operation (cont.)

Input applied to port select pins (3, 5, 7, 9, 11, 13) while pin 16 is selected will override the signal on pin 16 and close the respective ports. On standard switches, pin 16 can be permanently connected to ground to allow the switch to open all RF ports at power up (assuming no input is present at any of the port select pins). Not available with Options 100 or T24.

# If pin 15 is not grounded, the logic circuit will not operate as expected, and damage to the switch will occur.

# Driving the switch

# **DC** power connection

- Connect pin 1 to supply (+20 VDC to +32 VDC)
- Connect pin 15 to chassis ground to enable the electronic positionindicating circuitry and drive logic circuitry.

WARNING: DAMAGE to switch will occur if pin 15 is not grounded.

#### **RF Path Selection**

To connect any two RF ports, apply control signal to the corresponding drive pins as shown below.

# Table 1. Agilent 87406B RF port drivepin control data (see figure 8 for driveconnection diagrams.)

RF Port	6	5	4	3	2
1	3, 13	3, 11	3, 9	3, 7	3, 5
2	5, 13	5, 11	5, 9	5, 7	
3	7, 13	7, 11	7, 9		
4	9, 13	9, 11			
5	11, 13	·			

Using Table 1, **select** (close) the desired RF path by connecting ground (Option 024 and Option 100) or applying TTL "High" (Option T24) to the corresponding "drive" pins.

**Unselect** (open) RF paths by disconnecting ground (Option 024 and Option 100) or applying TTL "Low" (Option T24) to the corresponding "drive" pins.

# Example: Configure the RF path from port 2 to port 5

Using the data in Table 1, select pins 5 and 11 while ensuring no other pins are selected.

RF Port	1	2	3	4	5	6	Open all*
Drive pin	3	5	7	9	11	13	16
Option 024, Option 100	U	G	U	U	G	U	X**
Options T24, 100	L	H	L	L	H	L	X**

U = Ungrounded, G = Grounded, L = TTL "Low", H = TTL "High", X = Don't care

\* "Open All Ports" is not available with Option 100 or Option T24.

\*\* "Open all RF Ports" feature is overridden by port selection.

Selected ports will be closed and unselected ports will be automatically opened by the internal logic circuits when new port selections are made. After the RF port is switched and magnetically latched, the solenoid current is interrupted by the solidstate position sensing circuitry. The drive voltage must be maintained to avoid RF path disconnection by the internal logic. For this reason, **pulsed drive is NOT recommended**. Use the 87606B if pulse drive, such as used on 70611A or 87130A, is desired.

#### **Open all RF ports**

Unselecting all RF ports and selecting Pin 16 on standard and Option T24 opens all RF ports:

#### **Break-before-make**

Remove the control inputs from the undesired port, then select the desired port. The internal logic will unselect the old port automatically upon application of the new port selection.

# Make-before-break

Select the new RF port while maintaining the control input on the original ports. Allow 15 ms for the switching action to be completed, then unselect the original port; the original port will be automatically disconnected by the internal logic.

Drive pin	3	5	7	9	11	13	16
Option 024	U	U	U	U	U	U	G
Option T24	L	L	L	L	L	L	H

U = Ungrounded, G = Ground, L = TTL "Low", H = TTL "High"

Selecting an RF port will override the "open all RF ports" for each selected port. If desired, pin 16 can be wired directly to ground (Option 024) or TTL "High" (Option T24) to open all RF ports at power-up.

# **Electronic position indicators**

The electronic position indicators consist of optically isolated, solid state relays that are driven by photoelectric sensors coupled to the mechanical position of the RF ports moving elements (Figure 5). The circuitry consists of a common that can be connected to an output corresponding to each RF port. When multiple RF ports are engaged, the position indicator corresponding to each closed RF port will be connected to common. The solid state relays are configured for AC and/or DC operation. (See indicator specifications.) The electronic position indicators require that the supply (20-32 VDC) be connected to pin 1 and ground connected to pin 15.

	PIN NUMBER	FUNCTION
<pre></pre>	2	COMMON
~~<	4	PORT 1
~<	6	PORT 2
	8	PORT 3
``~_<	10	PORT 4
~<	12	PORT 5
	14	PORT 6

Figure 5. Indicator function diagram

## **Specifications**

**Specifications** describe the instrument's warranted performance. **Supplemental** and **typical characteristics** are intended to provide information useful in applying the instrument by giving typical, but not warranted performance parameters.

<b>Maximum power rating:</b> Switching: Non-switching:	1 W average into 50 ohm internal loads 1 W average 50 W Peak (10 μs max, not to exceed 1 watt average)
Life:	5,000,000 cycles minimum
Switching time:	15 ms maximum
Indicator specifications (@25°C):	
Maximum withstand voltage:	60 V
Maximum current capacity:	150mA
Maximum "ON" resistance:	2.5 Ω
Typical "OFF" resistance:	10 G Ω



# **Supplemental characteristic**

# **Supplemental characteristics**

Insertion loss repeatability (measured at 25°C)	0.03 dB
Characteristic impedance	50 ohms
RF connectors	SMA (f)

#### **Reference conditions:**

- Cold switching only (NO Hot switching)
- Ambient temperature of 75°C or less
- Sea level (0.88 derating @ 15,000ft.)
- Load VSWR < 1.2 (see graph for derating above 1.2 VSWR)



# **Specifications (cont.)**

# Switch drive specifications

Conditions	Min	Nom	Max	Units
	20	24	32	V
Vcc=24 VDC	25	200 <sup>1</sup>	50	mA mA
	3		7	V
			0.8	V
	Conditions Vcc=24 VDC	ConditionsMinVcc=24 VDC20253	Conditions         Min         Nom           Vcc=24 VDC         20         24           200'         25         20           3         3         3	Conditions         Min         Nom         Max           Vcc=24 VDC         20         24         32           25         50         50           3         7         0.8

1. 200 mA is required for each RF port closed or open. Using "open all ports" (pin 16) will require up to 1200 mA (6 ports times 200 mA each). See General Operation Section, page 3.

Frequency range	dc to 20 GHz
Insertion loss	0.34 dB + 0.033 x frequency (GHz) maximum
Isolation	100 dB minimum to 12 GHz 80 dB minimum from 12 to 15 GHz 70 dB minimum from 15 to 20 GHz
SWR	1.21 maximum from dc to 4 GHz 1.35 maximum from 4 to 10 GHz 1.5 maximum from 10 to 15 GHz 1.7 maximum from 15 to 18 GHz 1.9 maximum from 18 to 20 GHz

TTL control voltage states (Options T24/100)		
7.0		Maximum "on" state
	"High"	
3.0		Minimum "on" state
0.8	"Low"	Maximum "off" state



#### Figure 8. Drive connection diagrams

\* Open all ports pin is not available with Options 100/T24.



## Figure 7. Product outline

# **Environmental specifications**

Operating temperature	e: –25 to 75°C
Storage temperature:	–55 to 85°C
Temperature cycling:	–55 to 85°C, 10 cycles per MIL-STD-202F, Method 107D,
	Condition A (modified)
Vibration	
Operating:	7 g: 5 to 2000 Hz at 0.25 in p-p
Survival:	20 g: 20 to 2000 Hz at 0.06 in p-p, 4 min/cycle, 4 cycles/axis
Random:	.41 g (rms) 10 min/axis
Shock	
Half-sine:	500 g at 0.5 ms, 3 drops/direction, 18 total
Operating:	50 g at 6 ms, 6 directions
Moisture resistance:	65 °C, 95% RH, 10 days per MIL-STD-202F, Method 106E
Altitude storage:	50,000 feet (15,240 meters per MIL-STD-202F, Method 105C, Condition B)
RFI:	Per MIL-STD-461C, RE02, Part 4
Magnetic field:	<5 gauss 1/4 inch from surface

# **Physical specifications**

Dimensions:	Per figure 6
Weight:	229 gm (0.50 lb)

# Troubleshooting

Symptom	Probable cause
1. Will not switch	Not connected to supply
	• Supply <20 V
	<ul> <li>Supply current too low</li> </ul>
	<ul> <li>Not connected to ground</li> </ul>
	<ul> <li>Select line not at ground (std)</li> </ul>
	<ul> <li>TTL "Low" voltage too high (Options T24)</li> </ul>
2. Position indicators don't work	Supply not connected
	<ul> <li>Supply &lt;20 VDC</li> </ul>
	<ul> <li>Pin 15 not connected to ground</li> </ul>

# **Ordering information**

Coaxial Matrix Switch	
87406B	coaxial matrix switch dc to 20 GHz
Options	
To add options to	a product, use the following scheme:
Model:	87406b
Model options:	87406b-opt#1
	87406b-opt#2
DC Connectors (must choose one)	
87406B-161	16-pin DIP with quantity (one) ribbon cable, 24″ with SMA female connector
87406B-100	solder terminals
Control Logic (must choose one)	
87406B-T24	TTL and 5 V CMOS compatibility
87406B-024	24 V dc without TTL Logic
Calibration Documentation (optional)	
87406B-UK6	calibration data

# Driver

#### 11713A Attenuator switch driver

Drives up to 10 sections of switches or attenuators.

## 5061-0969 Accessory cable

Viking connector to bare tinned wires (60 inches long). Use (2) 5061-0969 to connect the 11713A to the 87406B Option 100 switch.

# **Configuration guide**

See publication 5963-2038E.

# www.agilent.com

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